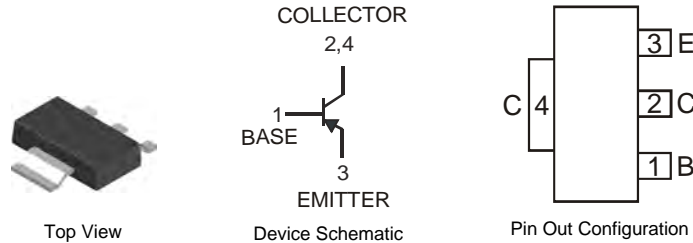


Features

- Ideally Suited for Automated Assembly Processes
- Complementary NPN Type Available (DJT4031N)
- Low Collector-Emitter Saturation Voltage
- Ideal for Medium Power Switching or Amplification Applications
- **Lead Free By Design/RoHS Compliant (Note 1)**
- **"Green" Device (Note 2)**

Mechanical Data

- Case: SOT-223
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish — Matte Tin annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.115 grams (approximate)



Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|------------------------------|-----------|-------|------|
| Collector-Base Voltage | V_{CBO} | -40 | V |
| Collector-Emitter Voltage | V_{CEO} | -40 | V |
| Emitter-Base Voltage | V_{EBO} | -6 | V |
| Peak Pulse Current | I_{CM} | -5 | A |
| Continuous Collector Current | I_C | -3 | A |
| Base Current | I_B | -1 | A |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------------|--------------------|
| Power Dissipation (Note 3) @ $T_A = 25^\circ\text{C}$ | P_D | 1.2 | W |
| Thermal Resistance, Junction to Ambient Air (Note 3) @ $T_A = 25^\circ\text{C}$ | $R_{\theta JA}$ | 104 | $^\circ\text{C/W}$ |
| Power Dissipation (Note 4) @ $T_A = 25^\circ\text{C}$ | P_D | 2 | W |
| Thermal Resistance, Junction to Ambient Air (Note 4) @ $T_A = 25^\circ\text{C}$ | $R_{\theta JA}$ | 62.5 | $^\circ\text{C/W}$ |
| Operating and Storage Temperature Range | T_J, T_{STG} | -55 to +150 | $^\circ\text{C}$ |

- Notes:
1. No purposefully added lead.
 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 3. Device mounted on FR-4 PCB with minimum recommended pad layout.
 4. Device mounted on FR-4 PCB with 1 inch² copper pad layout.

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Conditions |
|--------------------------------------|---------------|-----|-----|------|------------------|---|
| OFF CHARACTERISTICS (Note 5) | | | | | | |
| Collector-Base Breakdown Voltage | $V_{(BR)CBO}$ | -40 | — | — | V | $I_C = -100\mu\text{A}$ |
| Collector-Emitter Breakdown Voltage | $V_{(BR)CEO}$ | -40 | — | — | V | $I_C = -10\text{mA}$ |
| Emitter-Base Breakdown Voltage | $V_{(BR)EBO}$ | -6 | — | — | V | $I_E = -50\mu\text{A}$ |
| Collector-Base Cutoff Current | I_{CBO} | — | — | -100 | nA | $V_{CB} = -40\text{V}, I_E = 0$ |
| | | — | — | -50 | μA | $V_{CB} = -40\text{V}, I_E = 0, T_A = 150^\circ\text{C}$ |
| Emitter-Base Cutoff Current | I_{EBO} | — | — | -100 | nA | $V_{EB} = -6\text{V}, I_C = 0$ |
| ON CHARACTERISTICS (Note 5) | | | | | | |
| DC Current Gain | h_{FE} | 220 | — | — | — | $V_{CE} = -1\text{V}, I_C = -0.5\text{A}$ |
| | | 200 | — | 400 | | $V_{CE} = -1\text{V}, I_C = -1\text{A}$ |
| | | 100 | — | — | | $V_{CE} = -1\text{V}, I_C = -3\text{A}$ |
| Collector-Emitter Saturation Voltage | $V_{CE(SAT)}$ | — | — | -150 | mV | $I_C = -0.5\text{A}, I_B = -5\text{mA}$ |
| | | — | — | -200 | | $I_C = -1\text{A}, I_B = -10\text{mA}$ |
| | | — | — | -500 | | $I_C = -3\text{A}, I_B = -0.3\text{A}$ |
| Equivalent On-Resistance | $R_{CE(SAT)}$ | — | — | 167 | $\text{m}\Omega$ | $I_E = -3\text{A}, I_B = -0.3\text{A}$ |
| Base-Emitter Saturation Voltage | $V_{BE(SAT)}$ | — | — | -1.0 | V | $I_C = -1\text{A}, I_B = -0.1\text{A}$ |
| Base-Emitter Turn-on Voltage | $V_{BE(ON)}$ | — | — | -1.0 | V | $V_{CE} = -2\text{V}, I_C = -1\text{A}$ |
| SMALL SIGNAL CHARACTERISTICS | | | | | | |
| Transition Frequency | f_T | — | 150 | — | MHz | $V_{CE} = -10\text{V}, I_C = -100\text{mA}, f = 100\text{MHz}$ |
| Output Capacitance | C_{obo} | — | 35 | — | pF | $V_{CB} = -10\text{V}, f = 1\text{MHz}$ |
| Input Capacitance | C_{ibo} | — | 150 | — | pF | $V_{CB} = -5\text{V}, f = 1\text{MHz}$ |
| SWITCHING CHARACTERISTICS | | | | | | |
| Turn-On Time | t_{on} | — | 53 | — | ns | $V_{CC} = -10\text{V}, I_C = -2\text{A}, I_{B1} = -200\text{mA}$ |
| Delay Time | t_d | — | 12 | — | ns | |
| Rise Time | t_r | — | 41 | — | ns | |
| Turn-Off Time | t_{off} | — | 180 | — | ns | $V_{CC} = -10\text{V}, I_C = -2\text{A}, I_{B1} = I_{B2} = -200\text{mA}$ |
| Storage Time | t_s | — | 146 | — | ns | |
| Fall Time | t_f | — | 34 | — | ns | |

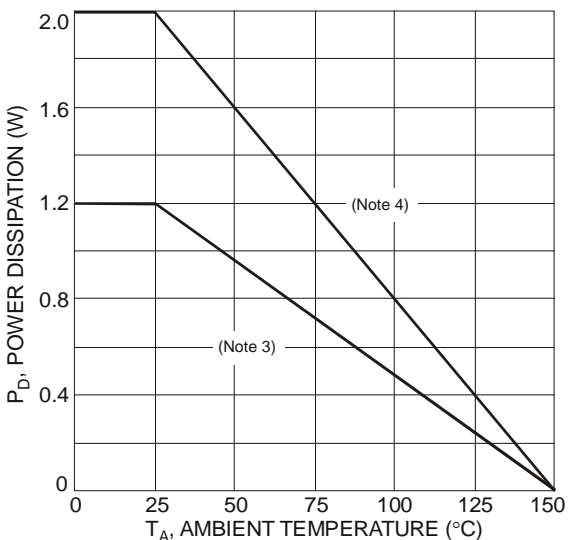
 Notes: 5. Measured under pulsed conditions. Pulse width = 300 μs . Duty cycle $\leq 2\%$.


Fig. 1 Power Dissipation vs. Ambient Temperature

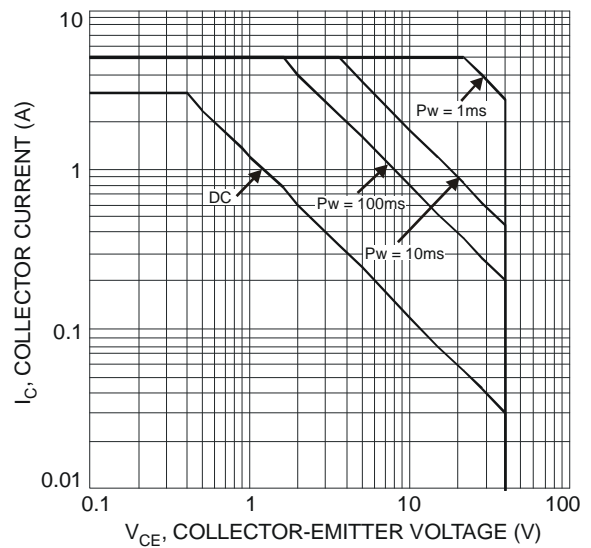


Fig. 2 Typical Collector Current vs. Collector-Emitter Voltage (Note 3)

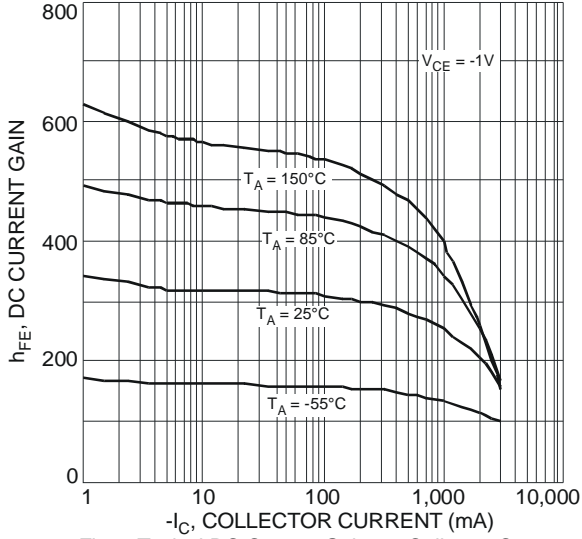


Fig. 3 Typical DC Current Gain vs. Collector Current

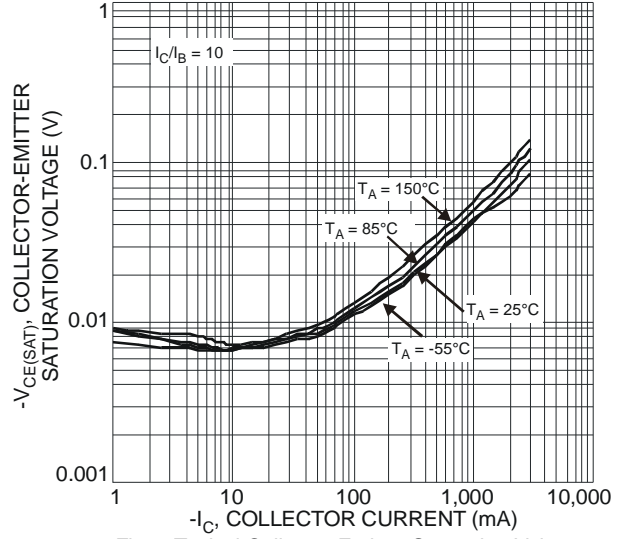


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

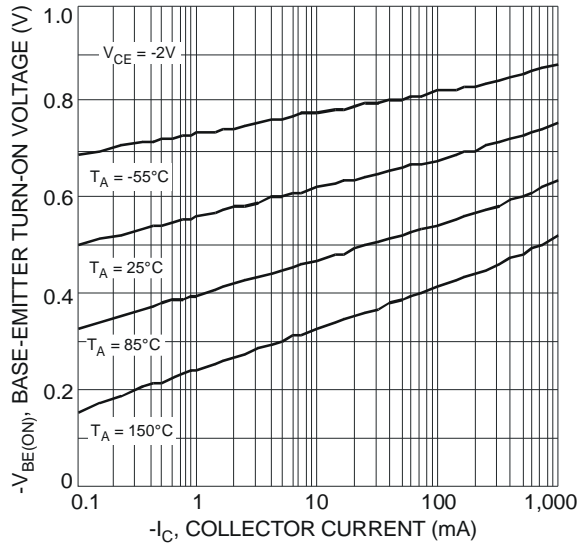


Fig. 5 Typical Base-Emitter Turn-On Voltage vs. Collector Current

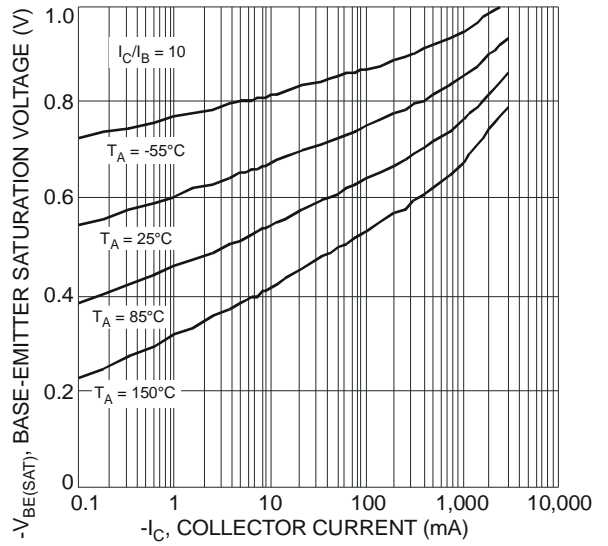


Fig. 6 Typical Base-Emitter Saturation Voltage vs. Collector Current

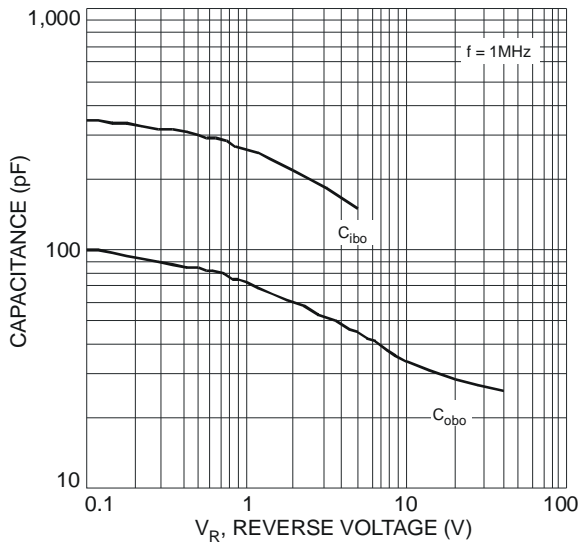


Fig. 7 Typical Capacitance Characteristics

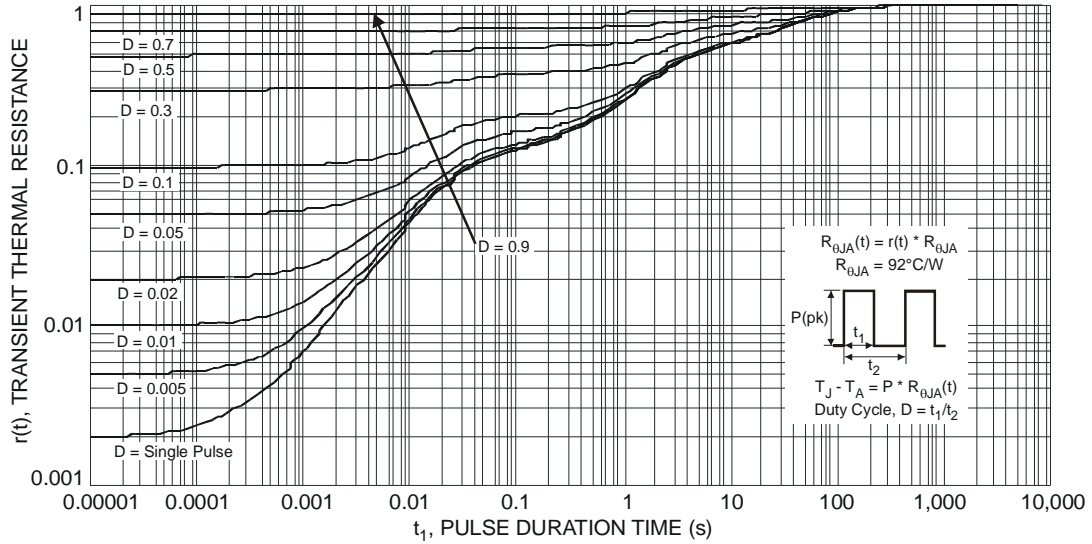


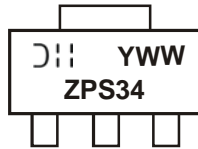
Fig. 8 Transient Thermal Response (Note 3)

Ordering Information (Note 6)

| Part Number | Case | Packaging |
|-------------|---------|------------------|
| DJT4030P-13 | SOT-223 | 2500/Tape & Reel |

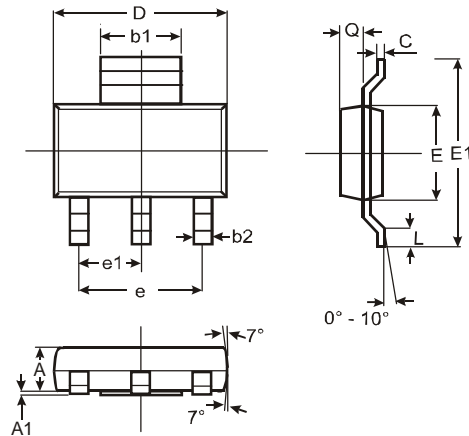
Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



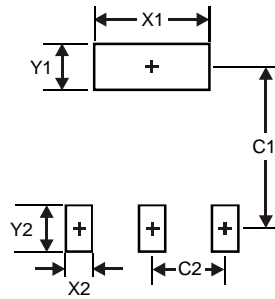
ZPS34 = Product Type Marking Code
 YWW = Date Code Marking
 Y = Last digit of year (ex: 8 = 2008)
 WW = Week code 01 - 52

Package Outline Dimensions



| SOT-223 | | | |
|----------------------|-------|------|------|
| Dim | Min | Max | Typ |
| A | 1.55 | 1.65 | 1.60 |
| A1 | 0.010 | 0.15 | 0.05 |
| b1 | 2.90 | 3.10 | 3.00 |
| b2 | 0.60 | 0.80 | 0.70 |
| C | 0.20 | 0.30 | 0.25 |
| D | 6.45 | 6.55 | 6.50 |
| E | 3.45 | 3.55 | 3.50 |
| E1 | 6.90 | 7.10 | 7.00 |
| e | — | — | 4.60 |
| e1 | — | — | 2.30 |
| L | 0.85 | 1.05 | 0.95 |
| Q | 0.84 | 0.94 | 0.89 |
| All Dimensions in mm | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| X1 | 3.3 |
| X2 | 1.2 |
| Y1 | 1.6 |
| Y2 | 1.6 |
| C1 | 6.4 |
| C2 | 2.3 |

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